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JANG, Sung-Wook [KR/KR]; 2/3, 241-1 Sangsu-dong, Mapo-gu, Seoul 121-828 (KR).

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(74) Agents: **LEE, Sang-Yong** et al.; 4F., Byukcheon Bldg., 1597-5, Seocho-dong Seocho-gu, Seoul 137-876 (KR).

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(71) Applicant (*for all designated States except US*): **LS CABLE LTD.** [KR/KR]; 19-20F ASEM Tower 159 Samsung-dong, Gangnam-gu, Seoul 135-090 (KR).

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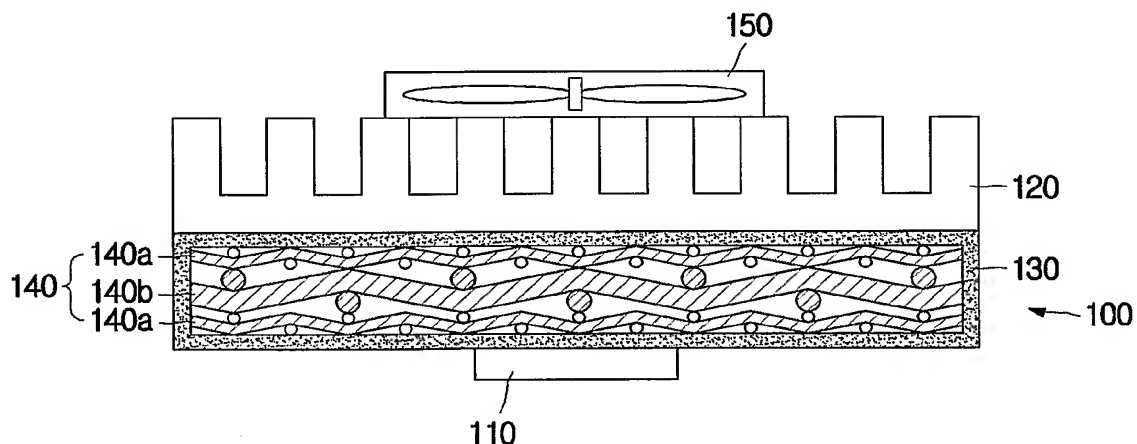
(72) Inventors; and

(75) Inventors/Applicants (*for US only*): **LEE, Yong-Duck** [KR/KR]; 109-2001 Moraksan Hyundai Apt., Ojeon-dong, Euiwang-si, Gyeonggi-do 437-070 (KR). **OH, Min-Jung** [KR/KR]; 112-301 Samsung Raemian Apt., Anyang 1-dong, Manan-gu, Anyang-si, Gyeonggi-do 430-710 (KR). **KIM, Hyun-Tae** [KR/KR]; 102, 104-120 Dangsan-dong 6-ga, Yeongdeungpo-gu, Seoul 150-807 (KR).

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(54) Title: FLAT PLATE HEAT TRANSFER DEVICE



(57) Abstract: Disclosed is a flat plate heat transfer device, which includes a thermally conductive flat case installed between a heat source and a heat emitting unit and containing a working fluid evaporated with absorbing heat from the heat source and condensed with emitting heat to the heat emitting unit; and a mesh layer aggregate installed in the flat case and having a structure that a fine mesh layer for providing a flowing path of liquid and a coarse mesh layer for providing a flowing path of liquid and a dispersion path of vapor simultaneously are laminated. On occasions, the coarse and the fine mesh layers are alternately laminated repeatedly, and the fine mesh layer is replaced with a wick structure. The coarse mesh layer is preferably a screen mesh layer with wire diameter of 0.2 mm ~ 0.4 mm and mesh number of 10 ~ 20. This device improves heat transfer performance.

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